



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)} max	I _{D MAX} T _A = +25°C
04		0.45Ω @ $V_{GS} = 4.5V$	
Q1 N-Channel	25V	0.60Ω @ $V_{GS} = 2.7V$	0.68A
		0.73Ω @ V _{GS} = 1.8V	
00		1.1Ω @ $V_{GS} = -4.5V$	
Q2 P-Channel	-25V	1.5Ω @ V _{GS} = -2.7V	-0.46A
1 Ondino		2.2Ω @ V _{GS} = -1.8V	

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- **DC-DC Converters**
- Power Management Functions

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

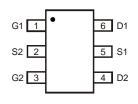
Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.013 grams (Approximate)

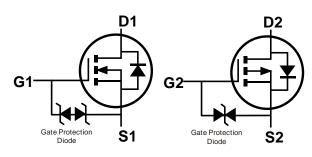




Top View



Top View



Q1 N-Channel Q2 P-Channel

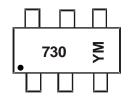
Ordering Information (Note 4)

Part Number	Case	Packaging
DMC3730UVT-7	TSOT26	3000 / Tape & Reel
DMC3730UVT-13	TSOT26	10,000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



730 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Kev

Date Code Ite	"											
Year	2017	2018	20	019	2020	2021		2022	2023	20:	24	2025
Code	E	F		G	Н			J	K	L	-	М
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Characteristic			Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit
Drain-Source Voltage			V_{DSS}	25	-25	V
Gate-Source Voltage			V _{GSS}	±8	±8	V
Continuous Drain Current (Note 6) N-Channel: V _{GS} = 4.5V P-Channel: V _{GS} = -4.5V	Steady State	T _A = +25°C	I _D	0.68	-0.46	А
Maximum Continuous Body Diode Forward Curre	Is	0.3	-0.3	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	3	-2.5	Α		

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	0.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	180	°C/W
Total Power Dissipation (Note 6)		P _D	0.9	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	140	°C/W
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	60	C/VV
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

Electrical Characteristics N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)								
Drain-Source Breakdown Voltage	BV _{DSS}	25	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	-	-	1.0	μΑ	$V_{DS} = 20V$, $V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	ī	-	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	V _{GS(TH)}	0.45	0.7	1.1	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		
	R _{DS(ON)}	-	0.28	0.45		$V_{GS} = 4.5V, I_D = 0.5A$		
Static Drain-Source On-Resistance		-	0.33	0.60	Ω	$V_{GS} = 2.7V, I_D = 0.25A$		
		-	0.39	0.73		$V_{GS} = 1.8V, I_D = 0.1A$		
Diode Forward Voltage	V_{SD}	-	0.75	1.2	V	$V_{GS} = 0V, I_{S} = 0.5A$		
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	Ciss	-	50	-	pF	101/11/		
Output Capacitance	Coss	-	28	-	pF	$V_{DS} = 10V, V_{GS} = 0V,$ -f = 1.0MHz		
Reverse Transfer Capacitance	C _{rss}	ī	9	-	pF			
Gate Resistance	Rg	-	64	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge	Qg	-	1.64	-	nC	V 5V 1 0 5A		
Gate-Source Charge	Q_{gs}	-	0.38	-	nC	$V_{DS} = 5V, I_D = 0.5A,$		
Gate-Drain Charge	Q_{gd}	-	0.45	-	nC	$V_{GS} = 4.5V$		
Turn-On Delay Time	t _{D(ON)}	-	3	-	ns			
Turn-On Rise Time	t _R	-	8	-	ns	$V_{GS} = 4.5V, V_{DS} = 6V,$		
Turn-Off Delay Time	t _{D(OFF)}	-	17	-	ns	$R_g = 50\Omega, I_D = 0.5A$		
Turn-Off Fall Time	t _F	-	13	-	ns			



Electrical Characteristics P-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

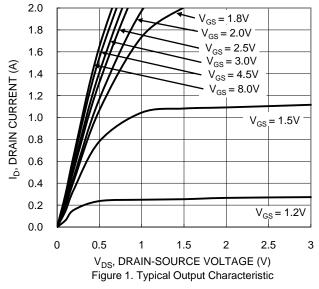
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)				•		•	
Drain-Source Breakdown Voltage	BV _{DSS}	-25	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	ı	=	-1.0	μA	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±10	μA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	<u>.</u>						
Gate Threshold Voltage	V _{GS(TH)}	-0.5	-0.8	-1.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
		1	0.65	1.1		$V_{GS} = -4.5V, I_D = -0.5A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	-	0.80	1.5	Ω	$V_{GS} = -2.7V, I_D = -0.25A$	
	, ,	-	1.0	2.2		$V_{GS} = -1.8V, I_D = -0.1A$	
Diode Forward Voltage	V _{SD}	-	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -0.5A$	
DYNAMIC CHARACTERISTICS (Note 8)	•			•		•	
Input Capacitance	C _{iss}	1	63	-	pF	401/1/	
Output Capacitance	Coss	-	34	-	pF	$V_{DS} = -10V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	10	-	pF		
Gate Resistance	Rq	-	178	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q _a	-	1.1	-	nC		
Gate-Source Charge	Q _{qs}	-	0.32	-	nC	$V_{DS} = -5V, I_{D} = -0.25A$	
Gate-Drain Charge	Q _{qd}	1	0.25	-	nC	$V_{GS} = -4.5V$	
Turn-On Delay Time	t _{D(ON)}	-	7	-	ns		
Turn-On Rise Time	t _R	-	9	-	ns	$V_{GS} = -4.5V, V_{DS} = -6V,$	
Turn-Off Delay Time	t _{D(OFF)}	-	55	-	ns	$R_{q} = 50\Omega, I_{D} = -0.5A$	
Turn-Off Fall Time	t _F	-	35	-	ns	7	

Notes:

- Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.



Typical Characteristics - N-CHANNEL



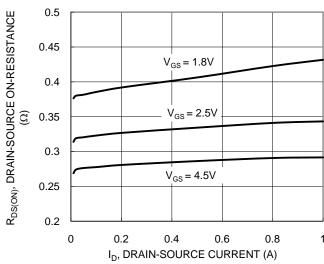
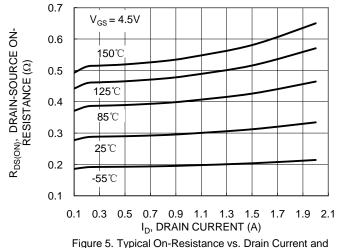


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage



Junction Temperature

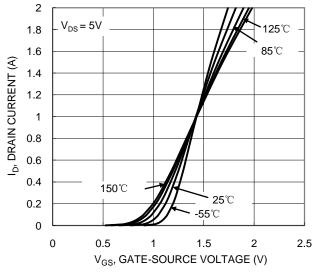


Figure 2. Typical Transfer Characteristic

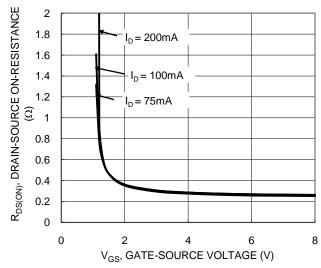


Figure 4. Typical Transfer Characteristic

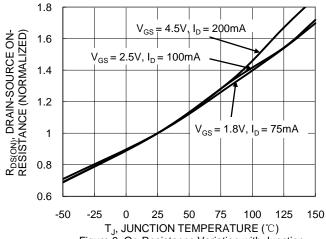
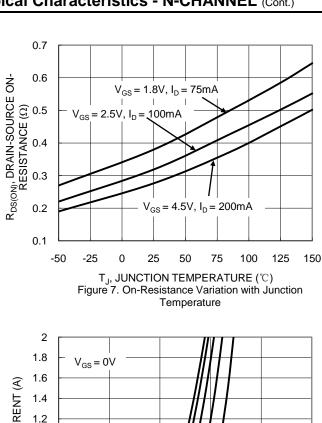
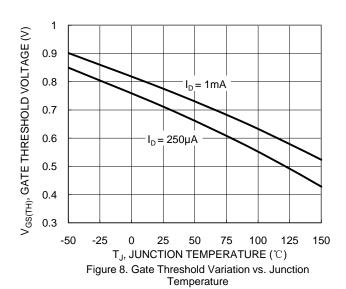


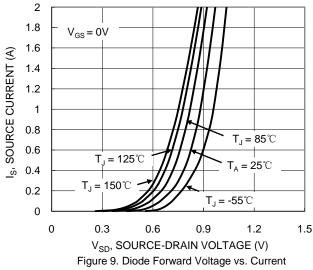
Figure 6. On-Resistance Variation with Junction
Temperature

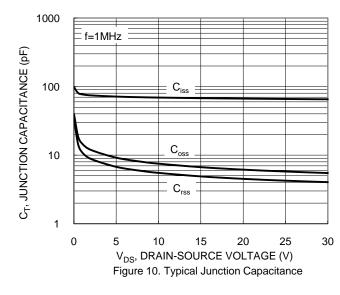


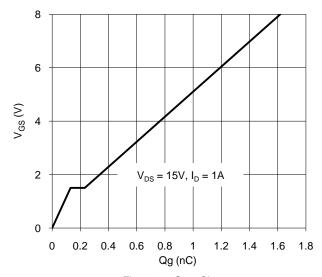
Typical Characteristics - N-CHANNEL (Cont.)











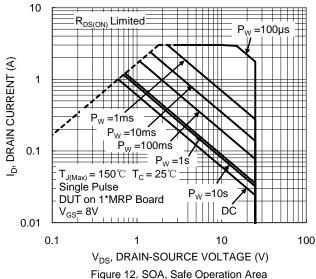
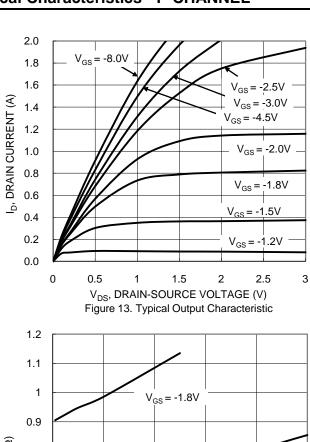


Figure 11. Gate Charge



Typical Characteristics - P-CHANNEL



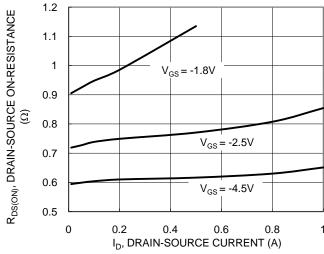


Figure 15. Typical On-Resistance vs. Drain Current and Gate Voltage

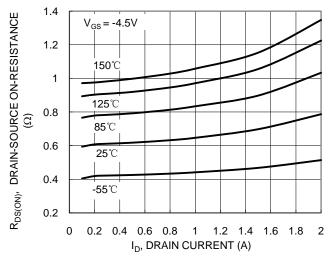
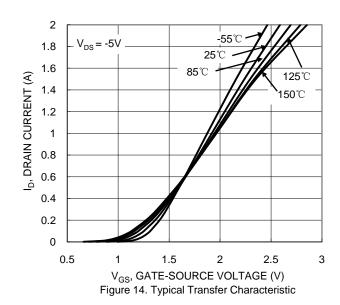


Figure 17. Typical On-Resistance vs. Drain Current and Junction Temperature



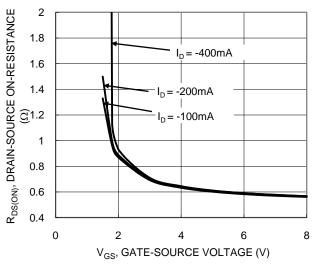


Figure 16. Typical Transfer Characteristic

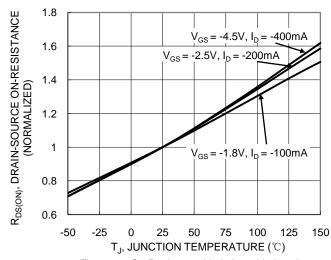


Figure 18. On-Resistance Variation with Junction Temperature



Typical Characteristics - P-CHANNEL (Cont.)

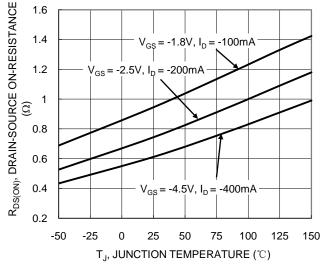


Figure 19. On-Resistance Variation with Junction Temperature

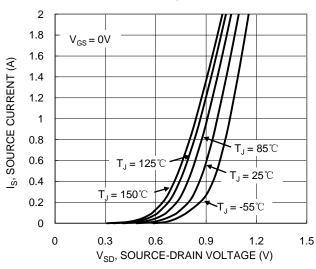


Figure 21. Diode Forward Voltage vs. Current

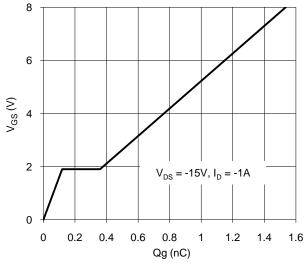


Figure 23. Gate Charge

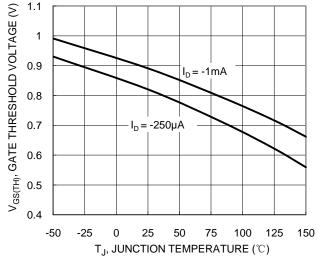


Figure 20. Gate Threshold Variation vs. Junction Temperature

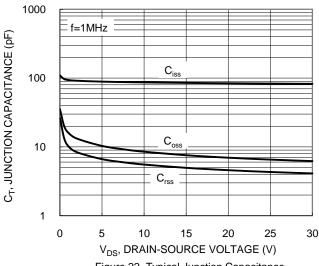
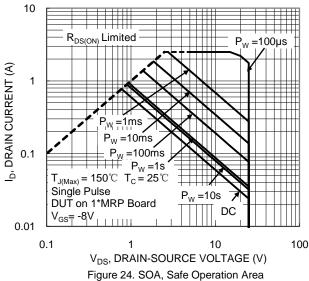


Figure 22. Typical Junction Capacitance





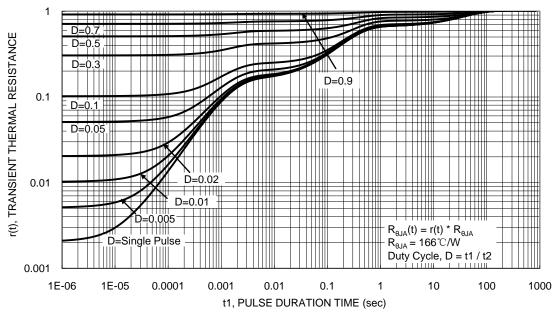
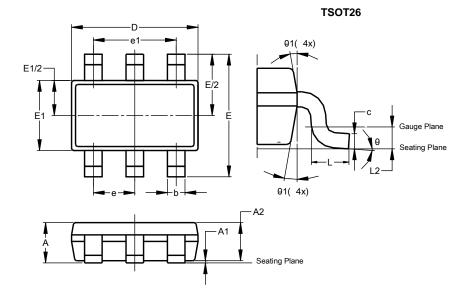


Figure 25. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

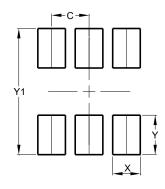


	TSOT26								
Dim	Min	Max	Тур						
Α	-	1.00	-						
A1	0.010	0.100	-						
A2	0.840	0.900	-						
D	2.800	3.000	2.900						
E	2	2.800 BSC							
E1	1.500	1.700	1.600						
b	0.300	0.450	-						
С	0.120	0.200	-						
е	0.950 BSC								
e1	1	.900 BS	С						
L	0.30	0.50	_						
L2	0	.250 BS	С						
θ	0°	8°	4°						
θ1	4°	12°	-						
Α	II Dimen	sions in	mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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